

Atmel AT24C04C and Atmel AT24C08C

I²C-Compatible, (2-wire) Serial EEPROM 4-Kbit (512 x 8), 8-Kbit (1024 x 8)

DATASHEET

Standard Features

- Low-voltage and standard-voltage operation
 - V_{CC} = 1.7V to 5.5V
- Internally organized as 512 x 8 (4K), or 1024 x 8 (8K)
- I²C-compatible (2-wire) serial interface
- Schmitt Trigger, filtered inputs for noise suppression
- Bidirectional data transfer protocol
- 1MHz (2.5V, 2.7V, 5V), 400kHz (1.7V) compatibility
- Write Protect pin for hardware data protection
- 16-byte Page Write mode
- Partial page writes allowed
- Self-timed write cycle (5ms max)
- High-reliability
 - Endurance: 1 million write cycles
 - Data retention: 100 years
- Green package options (Pb/Halide-free/RoHS compliant)
 - 8-lead PDIP, 8-lead SOIC, 8-lead TSSOP, 8-pad UDFN, 5-lead SOT23, and 8-ball VFBGA
- Die options: wafer form and tape and reel

Description

The Atmel[®] AT24C04C and AT24C08C provides 4096/8192 bits of Serial Electrically Erasable and Programmable Read-Only Memory (EEPROM) organized as 512/1024 words of eight bits each. The device is optimized for use in many industrial and commercial applications where low-power and low-voltage operation are essential. AT24C04C/08C is available in space-saving 8-lead PDIP, 8-lead JEDEC SOIC, 8-lead TSSOP, 8-pad UDFN, 5-lead SOT23, and 8-ball VFBGA packages and is accessed via a 2-wire serial interface.

Table 1. Pin Configuration

Pin Name	Function
NC	No Connect
A ₁	Address input (4K only)
A ₂	Address input
SDA	Serial data
SCL	Serial clock input
WP	Write protect
GND	Ground
V _{CC}	Power supply

Note: 1. For use of 5-lead SOT23, the software A2 and A1 bits in the device address word must be set to zero to properly communicate.

8-lead	PDIP	8-	lead SOI	С
		NC 🖂	1 8	
A₁/NC □ 2	7 🗆 WP	A1/NC	2 7	- WP
A2 🗆 3	6 🗆 SCL	A ₂	3 6	SCL
GND 🗌 4	5 🗆 SDA	GND 🖂	4 5	SDA
8-lead	TSSOP	8-1	lead UDF	N
NC 🗆 1	8 🗆 V _{CC}	V _{CC}	8 1	NC
A₁/NC □ 2	7 🗆 WP	WP	7 2	A ₁ /NC
A₂ □ 3	6 🗆 SCL	SCL	6 3	A ₂
GND 🗌 4	5 🗆 SDA	SDA	5 4	GND
		Bo	ottom Vie	W
5-lead	SOT23	8-1	oall VFB0	GA
SCL 1	5 WP	V _{CC}	8 1	NC
	-	WP	7 2	A ₁ /NC
GND 2		SCL	6 3	A ₂
SDA 3	4 V _{CC}	SDA	5 4	GND
		Bo	ottom Vie	W

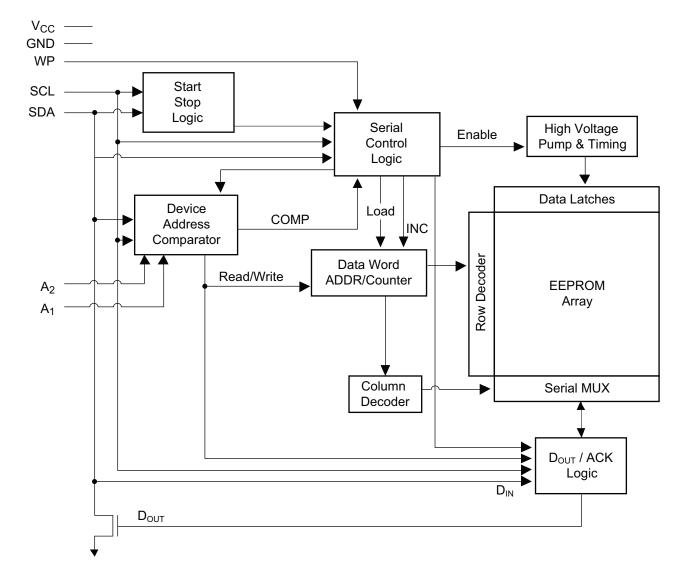


1. Absolute Maximum Ratings

Operating Temperature55°C to +125°C
Storage Temperature65°C to +150°C
Voltage on any pin with respect to ground–1.0V to +7.0V
Maximum Operating Voltage 6.25V
DC Output Current 5.0mA

*Notice: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2. Block Diagram





3. Pin Description

Serial Clock (SCL): The SCL input is used to positive edge clock data into each EEPROM device and negative edge clock data out of each device.

Serial Data (SDA): The SDA pin is bidirectional for serial data transfer. This pin is open-drain driven and may be wire-ORed with any number of other open-drain or open-collector devices.

Device/Page Addresses (A₂ and A₁): The AT24C04C uses the A₂ and A₁ inputs for hard wire addressing allowing a total of four 4K devices to be addressed on a single bus system. Pin 1 is a no connect and can be connected to ground (see Section 6. "Device Addressing" on page 10). The AT24C08C only uses the A₂ input for hardware addressing and a total of two 8K devices may be addressed on a single bus system. The A₀ and A₁ pins are no connects and can be connected to ground (see Section 6. "Device Addressing" on page 10).

Write Protect (WP): AT24C04C/08C has a Write Protect pin that provides hardware data protection. The Write Protect pin allows normal read/write operations when connected to Ground (GND). When the Write Protect pin is connected to V_{CC} , the write protection feature is enabled and operates as shown in Table 3-1.

Table 3-1. Write Protect

WP Pin	Part of the Array Protected
Status	Atmel AT24C04C/08C
At V _{CC}	Full array
At GND	Normal read/write operations



4. Memory Organization

Atmel AT24C04C, 4K Serial EEPROM: Internally organized with 32 pages of 16 bytes each, the 4K requires a 9-bit data word address for random word addressing.

Atmel AT24C08C, 8K Serial EEPROM: Internally organized with 64 pages of 16 bytes each, the 8K requires a 10-bit data word address for random word addressing.

Table 4-1. Pin Capacitance⁽¹⁾

Applicable over recommended operating range from $T_A = 25^{\circ}C$, f = 1.0MHz, $V_{CC} = +1.7V$ to +5.5V

Symbol	Test Condition	Мах	Units	Conditions
C _{I/O}	Input/Output capacitance (SDA)	8	pF	V _{I/O} = 0V
C _{IN}	Input capacitance (A ₀ , A ₁ , A ₂ , SCL)	6	pF	V _{IN} = 0V

Note: 1. This parameter is characterized and is not 100% tested.

Table 4-2. DC Characteristics

Applicable over recommended operating range from: $T_{AI} = -40^{\circ}C$ to +85°C, $V_{CC} = +1.7V$ to +5.5V (unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Мах	Units
V _{CC1}	Supply Voltage		1.7		5.5	V
V _{CC2}	Supply Voltage		4.5		5.5	V
I _{CC}	Supply Current V_{CC} = 5.0V	Read at 100kHz		0.4	1.0	mA
I _{CC}	Supply Current V_{CC} = 5.0V	Write at 100kHz		2.0	3.0	mA
I _{SB1}	Standby Current V _{CC} = 1.7V	$V_{IN} = V_{CC} \text{ or } V_{SS}$			1.0	μΑ
I _{SB2}	Standby Current V_{CC} = 5.5V	V_{IN} = V_{CC} or V_{SS}			6.0	μΑ
ILI	Input Leakage Current	$V_{IN} = V_{CC} \text{ or } V_{SS}$		0.10	3.0	μΑ
I _{LO}	Output Leakage Current	V_{OUT} = V_{CC} or V_{SS}		0.05	3.0	μA
V _{IL}	Input Low Level ⁽¹⁾		-0.6		V _{CC} x 0.3	V
V _{IH}	Input High Level ⁽¹⁾		V _{CC} x 0.7		V _{CC} + 0.5	V
V _{OL2}	Output Low Level V _{CC} = 3.0V	I _{OL} = 2.1mA			0.4	V
V _{OL1}	Output Low Level V _{CC} = 1.7V	I _{OL} = 0.15mA			0.2	V

Note: 1. V_{IL} min and V_{IH} max are reference only and are not tested.



Table 4-3. AC Characteristics

Applicable over recommended operating range from $T_{AI} = -40^{\circ}C$ to +85°C, $V_{CC} = +1.7V$ to +5.5V, CL = 1TTL Gate and 100pF (unless otherwise noted)

		1.	7V	2.5V, 2.7	7V, 5.0V	
Symbol	Parameter	Min	Max	Min	Max	Units
f _{SCL}	Clock Frequency, SCL		400		1000	kHz
t _{LOW}	Clock Pulse Width Low	1.2		0.4		μs
t _{HIGH}	Clock Pulse Width High	0.6		0.4		μs
t _l	Noise Suppression Time		100		50	ns
t _{AA}	Clock Low to Data Out Valid	0.1	0.9	0.05	0.55	μs
t _{BUF}	Time the bus must be free before a new transmission can start.	1.2		0.5		μs
t _{HD.STA}	Start Hold Time	0.6		0.25		μs
t _{SU.STA}	Start Setup Time	0.6		0.25		μs
t _{HD.DAT}	Data In Hold Time	0		0		μs
t _{SU.DAT}	Data In Setup Time	100		100		ns
t _R	Inputs Rise Time ⁽¹⁾		0.3		0.3	μs
t _F	Inputs Fall Time ⁽¹⁾		300		100	ns
t _{su.sto}	Stop Setup Time	0.6		.25		μs
t _{DH}	Data Out Hold Time	50		50		ns
t _{WR}	Write Cycle Time		5		5	ms
Endurance ⁽¹⁾	3.3V, +25°C, Page Mode		1 Mi	illion		Write Cycles

Note: 1. This parameter is ensured by characterization only.



5. Device Operation

Clock and Data Transitions: The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods (see Figure 5-4 on page 9). Data changes during SCL high periods will indicate a Start or Stop condition as defined below.

Start Condition: A high-to-low transition of SDA with SCL high is a Start condition which must precede any other command (see Figure 5-5 on page 9).

Stop Condition: A low-to-high transition of SDA with SCL high is a Stop condition. After a read sequence, the Stop command will place the EEPROM in a standby power mode (see Figure 5-5 on page 9).

Acknowledge: All addresses and data words are serially transmitted to and from the EEPROM in eight bit words. The EEPROM sends a zero to acknowledge that it has received each word. This happens during the ninth clock cycle.

Standby Mode: The Atmel AT24C04/08C features a low-power standby mode which is enabled:

- Upon power-up
- After the receipt of the Stop bit and the completion of any internal operations

2-wire Software Reset: After an interruption in protocol, power loss or system reset, any 2-wire part can be reset by following these steps:

- 1. Create a start bit condition
- 2. Clock nine cycles
- 3. Create another start bit followed by stop bit condition as shown below.

The device is ready for next communication after above steps have been completed.

Figure 5-1. Software Reset

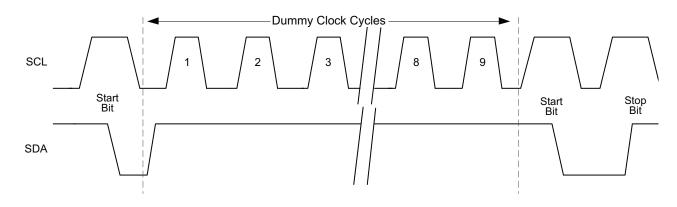
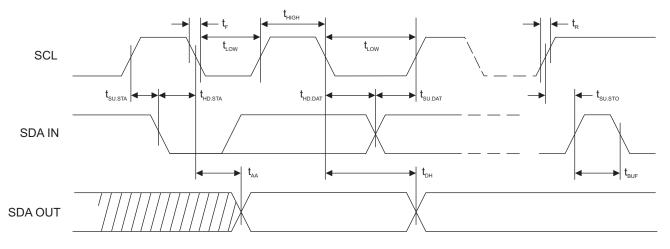




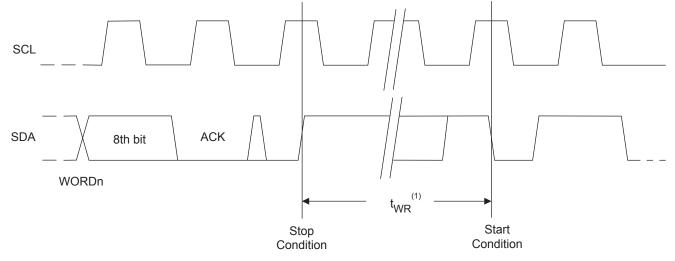
Figure 5-2. Bus Timing



SCL: Serial Clock, SDA: Serial Data I/O

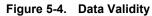
Figure 5-3. Write Cycle Timing

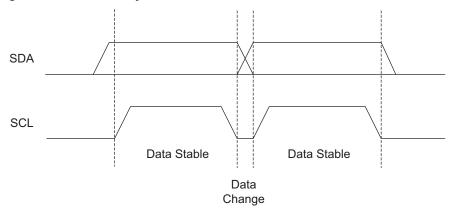
SCL: Serial Clock, SDA: Serial Data I/O

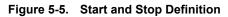


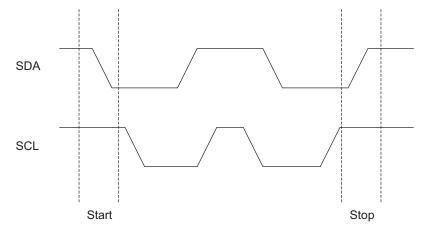
Notes: 1. The write cycle time t_{WR} is the time from a valid Stop condition of a write sequence to the end of the internal clear/write cycle.

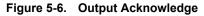


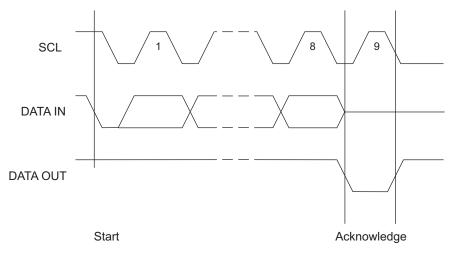












6. Device Addressing

Standard EEPROM Access: The 4K and 8K EEPROM device requires an 8-bit device address word following a start condition to enable the chip for a read or write operation. The device address word consists of a mandatory "1010" (0xA) sequence for the first four Most Significant Bits (MSB) as shown in Figure 8-1 on page 11. This is common to all the EEPROM devices.

The 4K EEPROM only uses the A2 and A1 device address bits with the third bit being a memory page address bit. The two device address bits must compare to their corresponding hard-wired input pins. The A_0 pin is no connect.

The 8K EEPROM only uses the A2 device address bit with the next two bits being for memory page addressing. The A2 address bit must compare to its corresponding hard-wired input pin. The A_1 and A_0 pins are no connect.

The eighth bit of the device address is the read/write operation select bit. A read operation is initiated if this bit is high and a write operation is initiated if this bit is low.

Upon a compare of the device address, the EEPROM will output a zero. If a compare is not made, the chip will return to a standby state.

For the SOT23 package offering, the 4K EEPROM software A2 and A1 bits in the device address word must be set to zero to properly communicate. The 8K EEPROM software A2 bit in the device address word must be set to zero to properly communicate.

7. Write Operations

Byte Write: A write operation requires an 8-bit data word address following the device address word and acknowledgment. Upon receipt of this address, the EEPROM will again respond with a zero and then clock in the first 8-bit data word. Following receipt of the 8-bit data word, the EEPROM will output a zero and the addressing device, such as a microcontroller, must terminate the write sequence with a Stop condition. At this time the EEPROM enters an internally timed write cycle, t_{WR}, to the nonvolatile memory. All inputs are disabled during this write cycle and the EEPROM will not respond until the write is complete (see Figure 8-2 on page 11).

Page Write: The 4K and 8K EEPROM devices are capable of a 16-byte Page Write.

A Page Write is initiated in the same way as a Byte Write, but the microcontroller does not send a Stop condition after the first data word is clocked in. Instead, after the EEPROM acknowledges receipt of the first data word, the microcontroller can transmit up to fifteen more data words. The EEPROM will respond with a zero after each data word received. The microcontroller must terminate the Page Write sequence with a Stop condition (see Figure 8-3 on page 12).

The data word address lower four bits are internally incremented following the receipt of each data word. The higher data word address bits are not incremented, retaining the memory page row location. When the word address, internally generated, reaches the page boundary, the following byte is placed at the beginning of the same page. If more than eight data words are transmitted to the EEPROM, the data word address will "roll over" and previous data will be overwritten.

Acknowledge Polling: Once the internally timed write cycle has started and the EEPROM inputs are disabled, Acknowledge Polling can be initiated. This involves sending a Start condition followed by the device address word. The read/write bit is representative of the operation desired. Only if the internal write cycle has completed will the EEPROM respond with a zero allowing the read or write sequence to continue.



8. Read Operations

Read operations are initiated in the same way as write operations with the exception that the read/write select bit in the device address word is set to one. There are three read operations: Current Address Read, Random Address Read, and Sequential Read.

Current Address Read: The internal data word address counter maintains the last address accessed during the last read or write operation, incremented by one. This address stays valid between operations as long as the chip power is maintained. The address "roll over" during read is from the last byte of the last memory page to the first byte of the first page. The address "roll over" during write is from the last byte of the current page to the first byte of the same page.

Once the device address with the read/write select bit set to one is clocked in and acknowledged by the EEPROM, the current address data word is serially clocked out. The microcontroller does not respond with an input zero but does generate a following stop condition (see Figure 8-4 on page 12).

Random Read: A random read requires a "dummy" byte write sequence to load in the data word address. Once the device address word and data word address are clocked in and acknowledged by the EEPROM, the microcontroller must generate another start condition. The microcontroller now initiates a Current Address Read by sending a device address with the read/write select bit high. The EEPROM acknowledges the device address and serially clocks out the data word. The microcontroller does not respond with a zero but does generate a following stop condition (see Figure 8-5 on page 12).

Sequential Read: Sequential Reads are initiated by either a Current Address Read or a Random Address Read. After the microcontroller receives a data word, it responds with an Acknowledge. As long as the EEPROM receives an Acknowledge, it will continue to increment the data word address and serially clock out sequential data words. When the memory address limit is reached, the data word address will "roll over" and the Sequential Read will continue. The Sequential Read operation is terminated when the microcontroller does not respond with a zero but does generate a following Stop condition (see Figure 8-6 on page 12).

Density	Access Area	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
4K	EEPROM	1	0	1	0	A ₂	A ₁	P0	R/W
8K	EEPROM	1	0	1	0	A ₂	P1	P0	R/W
	, , , , , , , , , , , , , , , , , , ,	MSB							LSB

Figure 8-1. Device Address

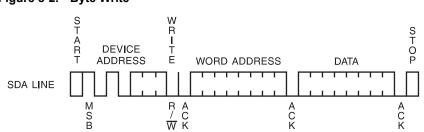


Figure 8-2. Byte Write



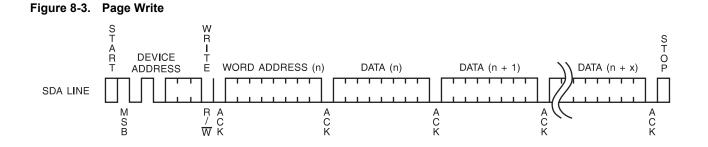
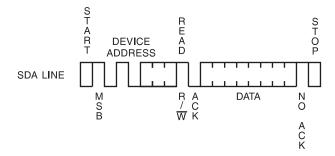


Figure 8-4. Current Address Read



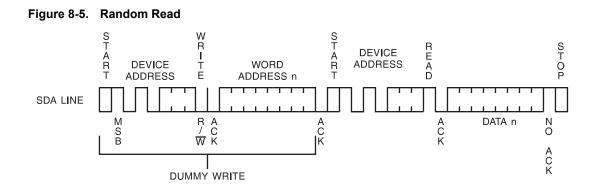
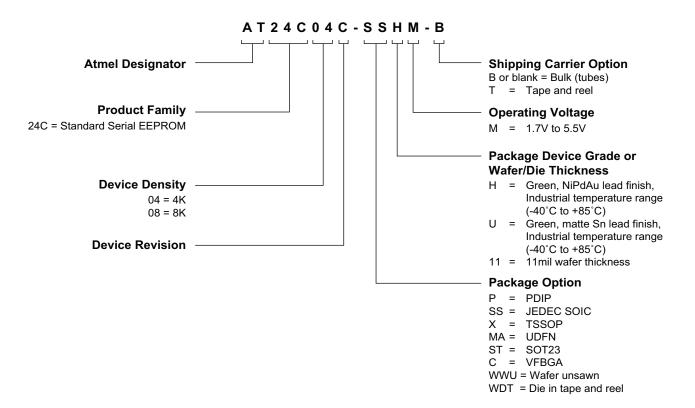


Figure 8-6. Sequential Read R E A D S T O P A C K A C K A C K DEVICE ADDRESS SDA LINE В А / С ₩К DATA n DATA n + 1 DATA n + 2 N O DATA n + xA C K



9. Ordering Code Detail



Atmel AT24C04C/08C [DATASHEET] 13 8787B-SEEPR-5/12



10. Product Markings

8-lead PDIP		8-lead SOIC	8-lead TSSOP	
) ###M		ATMLHYWW ###M AAAAAAAA C	ATHYWW ###M @ AAAAAAA	
8-lead UDFN		5-lead SOT-23	8-ball VFBGA	
2.0 x 3.0 mm Body			1.5 x 2.0 mm Body	
##= HM(YX) •	0	Top Mark	###U YMXX PIN 1	
Note 1: O designates pin 1 Note 2: Package drawings a				
	are not to scale	Truncation Code ###: 040		
Note 2: Package drawings a Catalog Number Truncat AT24C04C	are not to scale			
Note 2: Package drawings a Catalog Number Truncat AT24C04C AT24C08C	are not to scale	Truncation Code ###: 080	Voltages	
Note 2: Package drawings a Catalog Number Truncat AT24C04C AT24C08C Date Codes Y = Year 2: 2012 6: 2016 3: 2013 7: 2017 4: 2014 8: 2018	tion M = Month A: January B: February L: December	Truncation Code ###: 080	Voltages	Material
Note 2: Package drawings a Catalog Number Truncat AT24C04C AT24C08C Date Codes Y = Year 2: 2012 6: 2016 3: 2013 7: 2017 4: 2014 8: 2018 5: 2015 9: 2019	M = Month A: January B: February L: December	WW = Work Week of Asse 02: Week 2 04: Week 4 52: Week 52	embly M: 1.7V min	Matte Tin
Note 2: Package drawings a Catalog Number Truncat AT24C04C AT24C08C Date Codes Y = Year 2: 2012 6: 2016 3: 2013 7: 2017 4: 2014 8: 2018 5: 2015 9: 2019 Country of Assembly @ = Country of Assembly	M = Month A: January B: February L: December	Truncation Code ###: 080 WW = Work Week of Asso 02: Week 2 04: Week 4 52: Week 52 Lot Number	Voltages embly M: 1.7V min Grade/Lead Finish U: Industrial/I H: Industrial/I	Matte Tin
Note 2: Package drawings a Catalog Number Truncat AT24C04C AT24C08C Date Codes Y = Year 2: 2012 6: 2016 3: 2013 7: 2017 4: 2014 8: 2018 5: 2015 9: 2019 Country of Assembly	tion M = Month A: January B: February L: December	Truncation Code ###: 080 WW = Work Week of Asse 02: Week 2 04: Week 4 52: Week 52 Lot Number AAAA = Atmel Wafer Lot Number	mbly M: 1.7V min Grade/Lead Finish U: Industrial/I	Matte Tin
Note 2: Package drawings a Catalog Number Truncat AT24C04C AT24C08C Date Codes Y = Year 2: 2012 6: 2016 3: 2013 7: 2017 4: 2014 8: 2018 5: 2015 9: 2019 Country of Assembly @ = Country of Assembly Trace Code XX = Trace Code (Atmel L	tion M = Month A: January B: February L: December	Truncation Code ###: 080 WW = Work Week of Asse 02: Week 2 04: Week 4 52: Week 52 Lot Number AAAA = Atmel Wafer Lot Number	Voltages embly M: 1.7V min Grade/Lead Finish U: Industrial/I H: Industrial/I H: Industrial/I Atmel Truncation AT: AT: Atmel	Matte Tin



11. Ordering Codes

11.1 Atmel AT24C04C Ordering Information

Ordering Code	Package	Voltage	Operation Range
AT24C04C-PUM (Bulk Form Only)	8P3		
AT24C04C-SSHM-B ⁽¹⁾ (NiPdAu Lead Finish)	- 8S1		
AT24C04C-SSHM-T ⁽²⁾ (NiPdAu Lead Finish)	851		
AT24C04C-XHM-B ⁽¹⁾ (NiPdAu Lead Finish)	8X	1.7V to 5.5V	Lead-free/Halogen-free/ Industrial Temperature
AT24C04C-XHM-T ⁽²⁾ (NiPdAu Lead Finish)	07	1.7 V to 5.5 V	(–40°C to 85°C)
AT24C04C-MAHM-T ⁽²⁾ (NiPdAu Lead Finish)	8MA2	8MA2	
AT24C04C-STUM-T ⁽²⁾	5TS1	-	
AT24C04C-CUM-T ⁽²⁾	8U3-1	-	
AT24C04C-WWU11 ⁽³⁾	Die Sale	1.7V to 5.5V	Industrial Temperature (-40°C to 85°C)

Notes: 1. B = Bulk

- 2. T = Tape and reel
 - SOIC = 4K per reel
 - TSSOP, UDFN, SOT23, and VFBGA = 5K per reel
- 3. For Wafer sales, please contact Atmel Sales.

	Package Type
8P3	8-lead, 0.300" wide, Plastic Dual Inline (PDIP)
8S1	8-lead, 0.150" wide, Plastic Gull Wing Small Outline (JEDEC SOIC)
8X	8-lead, 4.4mm body, Plastic Thin Shrink Small Outline (TSSOP)
8MA2	8-pad, 2.00mm x 3.00mm body, 0.50mm pitch, Plastic Ultra Thin Dual Flat No Lead (UDFN)
5TS1	5-lead, 2.90mm x 1.60mm body, Plastic Thin Shrink Small Outline (SOT23)
8U3-1	8-ball, 1.50mm x 2.00mm body, 0.50mm pitch, Die Ball Grid Array (VFBGA)



11.2 Atmel AT24C08C Ordering Information

Ordering Code	Package	Voltage	Operation Range
AT24C08C-PUM (Bulk form only)	8P3		
AT24C08C-SSHM-B ⁽¹⁾ (NiPdAu Lead Finish)	- 8S1		
AT24C08C-SSHM-T ⁽²⁾ (NiPdAu Lead Finish)	881 8X		
AT24C08C-XHM-B ⁽¹⁾ (NiPdAu Lead Finish)		1.7V to 5.5V	Lead-free/Halogen-free/ Industrial Temperature
AT24C08C-XHM-T ⁽²⁾ (NiPdAu Lead Finish)		1.7 V to 5.5 V	(-40°C to 85°C)
AT24C08C-MAHM-T ⁽²⁾ (NiPdAu Lead Finish)	8MA2	-	
AT24C08C-STUM-T ⁽²⁾	5TS1		
AT24C08C-CUM-T ⁽²⁾	8U3-1		
AT24C08C-WWU11 ⁽³⁾	Die Sale	1.7V to 5.5V	Industrial Temperature (–40°C to 85°C)

Notes: 1. B = Bulk

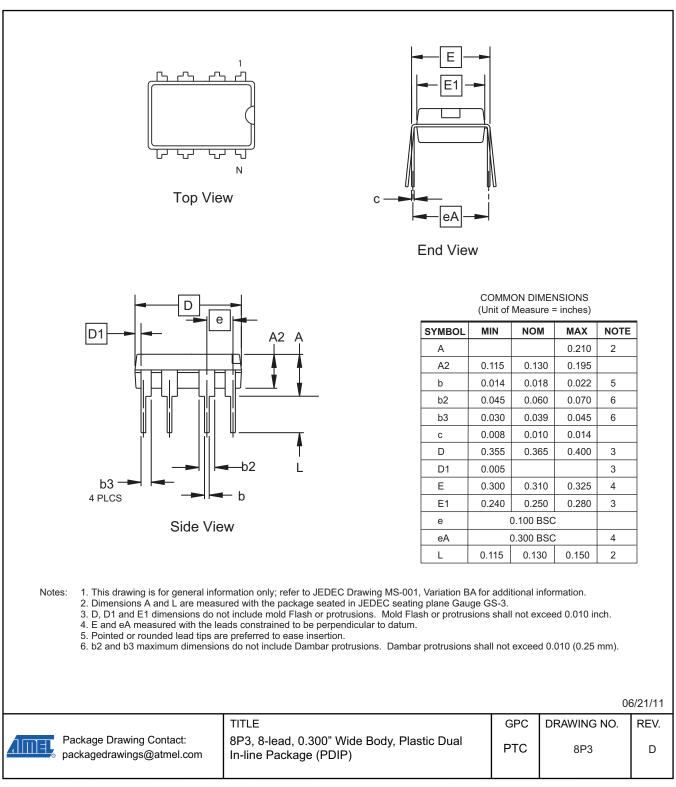
- 2. T = Tape and reel
 - SOIC = 4K per reel
 - TSSOP, UDFN, SOT23, and VFBGA = 5K per reel
- 3. For Wafer sales, please contact Atmel Sales.

Package Type			
8P3	8-lead, 0.300" wide, Plastic Dual Inline (PDIP)		
8S1	8-lead, 0.150" wide, Plastic Gull Wing Small Outline (JEDEC SOIC)		
8X	8-lead, 4.4mm body, Plastic Thin Shrink Small Outline (TSSOP)		
8MA2	8-pad, 2.00mm x 3.00mm body, 0.50mm pitch, Plastic Ultra Thin Dual Flat No Lead (UDFN)		
5TS1	5-lead, 2.90mm x 1.60mm body, Plastic Thin Shrink Small Outline (SOT23)		
8U3-1	8-ball, 1.50mm x 2.00mm body, 0.50mm pitch, Die Ball Grid Array (VFBGA)		

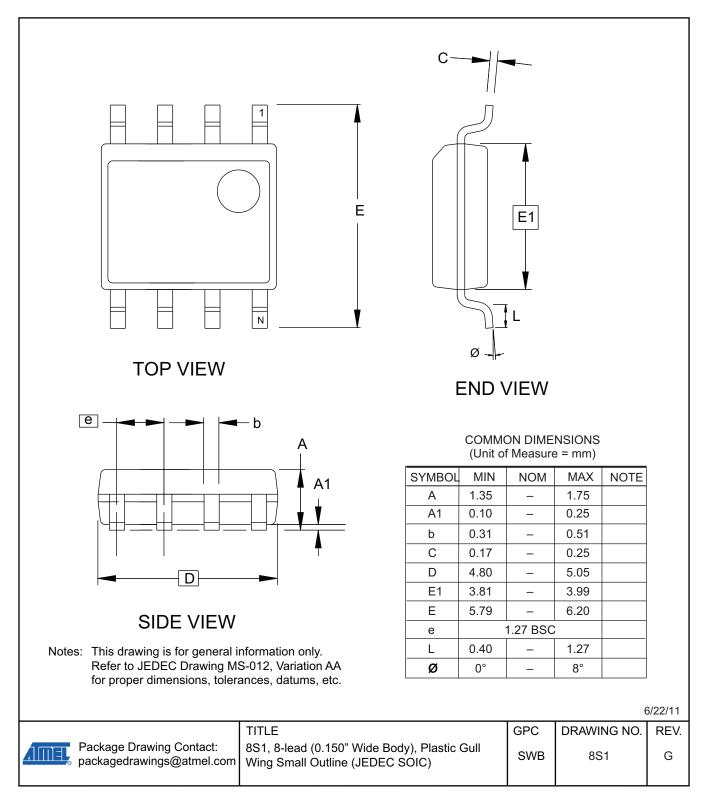


12. Packaging Information



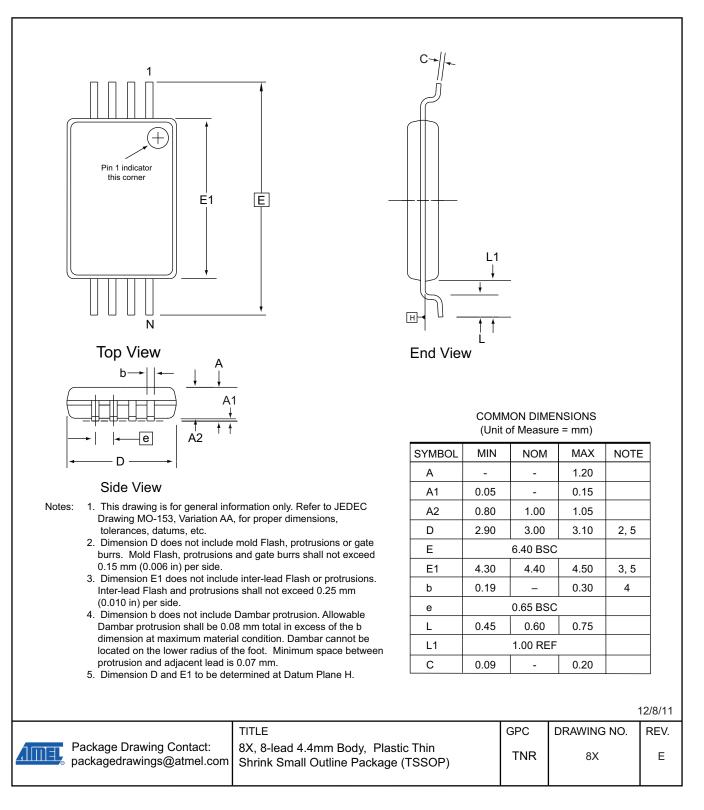








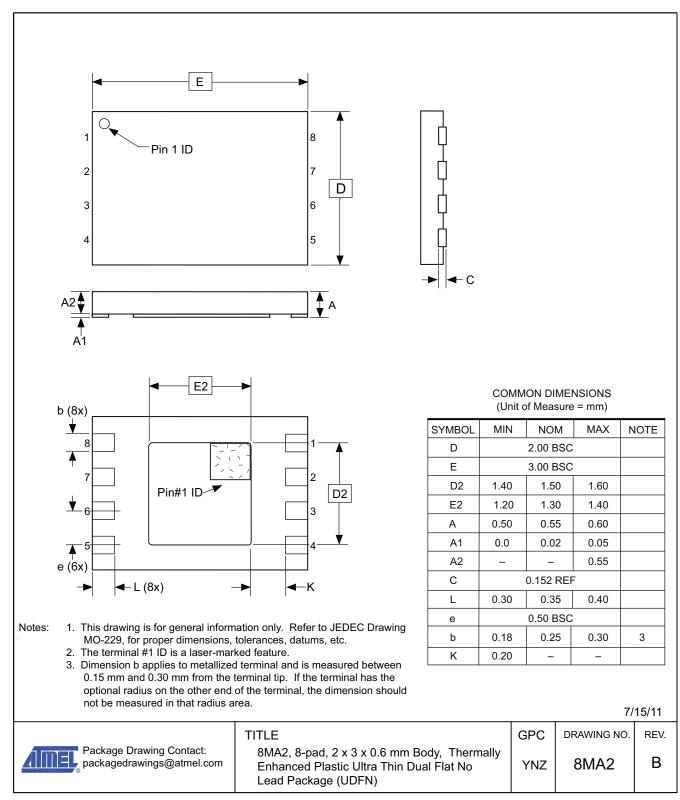
12.2 8X – TSSOP



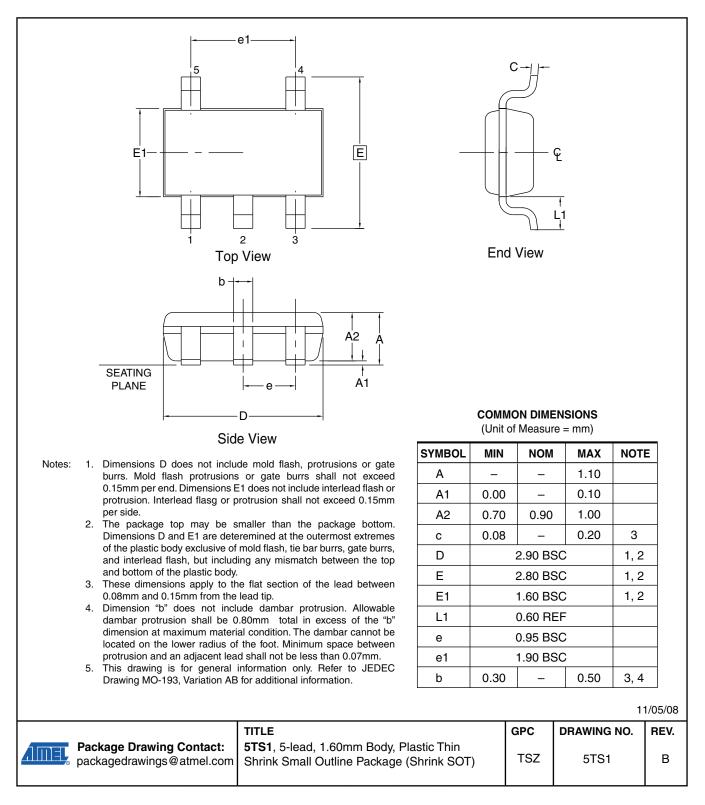


12.3 8MA2 - UDFN

AMEL

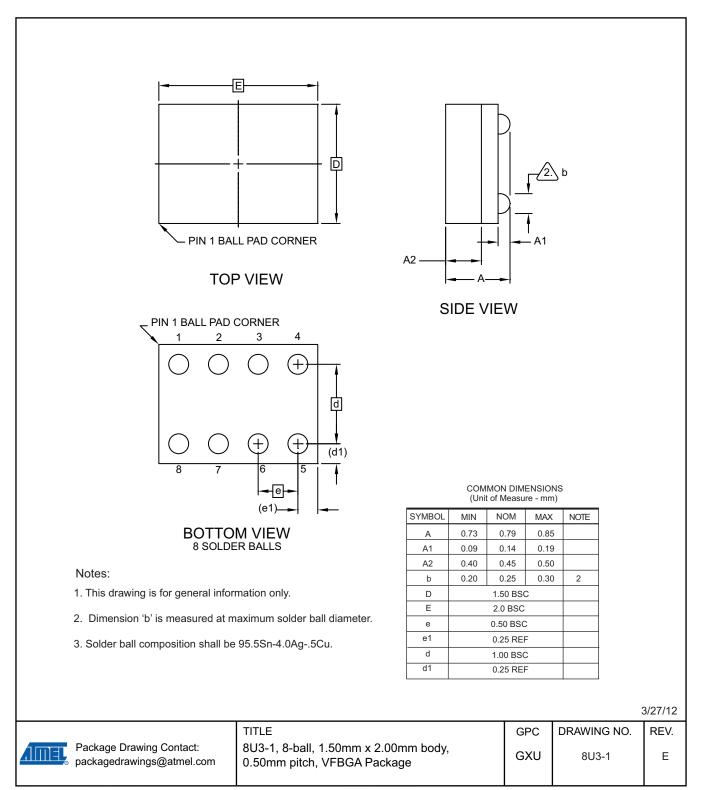


12.4 5TS1 – SOT23





12.5 8U3-1 – VFBGA





13. Revision History

Doc. Rev.	Date	Comments
8787B	05/2012	Removed preliminary status. Removed A ₀ signal from the block diagram. I _{SB2} parameter measured at 5.5V. In AC Characteristics table, changed 1.7V, 2.5V, 2.7V to 1.7 and 5.0V to 2.5V, 2.7V, 5.0V. Increased t ₁ maximum value from 50ns to 100ns. Endurance parameter is studied at 3.3V, to +25°C, Page mode. Removed Serial Number Read from read operations. Updated product markings. Updated 8X and 8U3-1 package drawings. Updated template.
8787A	10/2011	Initial document release.





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